Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

Created on: 05/31/2022

Details for "LM2756TMX/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LM2756TMX/NOPB	SNAGCU	Level-1-260C-UNLIM	Texas Instruments Electronics	YFQ 20	2.057x1.651x.35	4.2

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level			
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm		
Back Side Coating									
Other Inorganic Materials	Fused Silica	60676-86-0	0.191007	78.100071	781001	4.52915	45292		
Other Plastics and Rubber	Carbon Black	1333-86-4	0.001957	0.80019	8002	0.046404	464		
Other Plastics and Rubber	Other Filler		0.004402	1.799916	17999	0.10438	1044		
Thermoplastics	Ероху	85954-11-6	0.047201	19.299824	192998	1.119228	11192		
Sub-Total			0.244567	100	1000000	5.799163	57992		
Semiconductor Device	Semiconductor Device								
Ceramics / Glass	Doped Silicon	7440-21-3	2.768875	100	1000000	65.655454	656555		
Sub-Total			2.768875	100	1000000	65.655454	656555		
Solder Bump									
Copper and Its Alloys	Copper	7440-50-8	0.006019	0.499984	5000	0.142722	1427		
Nickel and Its Alloys	Nickel	7440-02-0	0.000602	0.050007	500	0.014275	143		
Other Nonferrous Metals and Alloys	Tin	7440-31-5	1.182772	98.250015	982500	28.045843	280458		
Precious Metals	Silver	7440-22-4	0.014446	1.199994	12000	0.342543	3425		
Sub-Total			1.203839	100	1000000	28.545383	285454		
Total			4.217281			100	1000000		

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page

Product Content Methodology
For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Tl bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. Tl may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/31/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures. TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the ROHS Annex II threshold, but that fall within one of the specific ROHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.